AMENDMENT TO THE CLAIMS:

Please cancel claims 6, 7, and 8, and amend claim 5 as follows:

LISTING OF CLAIMS:

1 and 2. (Cancelled)

3. (Previously amended) A semiconductor device for detecting neutrons comprising: a semiconductor substrate;

a boron containing layer containing isotope ¹⁰B, the layer being formed on said semiconductor substrate;

a PN junction formed on a surface area of said semiconductor substrate below said boron containing layer; wherein

electron - positive hole pairs are generated in a depletion layer of said PN junction by α rays generated by a reaction between said neutrons and said isotope 10 B, and the neutrons are detected on the basis of the quantity of electric charge of the electron - positive hole pairs; and

an analyzing circuit portion including a predetermined semiconductor element to estimate an energy spectrum of the α rays on said semiconductor substrate in a region other than the region where said neutrons are detected.

- 4. (Previously amended) A semiconductor device for detecting neutrons comprising: a semiconductor substrate;
- a boron containing layer containing isotope ¹⁰B, the layer being formed on said semiconductor substrate;
- a PN junction formed on a surface area of said semiconductor substrate below said boron containing layer; wherein

electron - positive hole pairs are generated in a depletion layer of said PN junction by α rays generated by a reaction between said neutrons and said isotope 10 B, and the neutrons are detected on the basis of the quantity of electric charge of the electron - positive hole pairs; and

an analyzing circuit portion including a predetermined semiconductor element on said semiconductor substrate in a region other than the region where said neutrons are detected, wherein the concentration of said isotope ¹⁰B in said boron containing layer in said analyzing circuit portion is lower than that of said isotope ¹⁰B of said boron containing layer in the region where said neutrons are detected.

5. (Currently amended) A semiconductor device according to claim 3, for detecting neutrons comprising:

a semiconductor substrate;

a boron containing layer containing isotope. 10B, the layer being formed on said semiconductor substrate;

a PN junction formed on a surface area of said semiconductor substrate below said boron containing layer; wherein

electron—positive hole pairs are generated in a depletion layer of said PN junction by α rays generated by a reaction between said neutrons and said isotope. ¹⁰B, and the neutrons are detected on the basis of the quantity of electric charge of the electron—positive hole pairs; and an analyzing circuit portion including a predetermined semiconductor element on said

semiconductor substrate in a region other than the region where said neutrons are detected, wherein no boron containing layer is provided on said analyzing circuit portion.

6, 7, and 8. (Cancelled)